ERRATA
TO THE MSP53C391 and MSP53C392 USER'S GUIDE
(TEXAS INSTRUMENTS LITERATURE NO. SPSU016, NOVEMBER 2000)

This document contains corrections and additions to information in the MSP53C391 and MSP53C392 User's Guide (TI Literature Number SPSU016, November 1999).

MSP53C391 Device Initialization

For proper operation, the MSP53C391 device should be initialized by sending the following command sequence of bytes:

F,F,F,F,0,A,0,1,0,0,F,F,F,F,F,F

Following this command sequence, the normal command sequence options are available as described in Section 4.2 and onwards.

The function of this sequence is to properly initialize the synthesis engine by speaking a short selection of LPC prior to speaking selections using other synthesis algorithms.

This initialization needs to be performed:

1. After you apply power to the device, or
2. When you reset the part by toggling the INIT pin.

MSP53C392 Device Initialization

For proper operation, the MSP53C392 device should be initialized by sending the following command sequence of bytes:

FF,FF,FF,FF,0A,01,00,FF,FF,FF,FF,FF

Following this command sequence, the normal command sequence options are available as described in Section 4.2 and onwards.

The function of this sequence is to properly initialize the synthesis engine by speaking a short selection of LPC prior to speaking selections using other synthesis algorithms.

This initialization needs to be performed:

1. After you apply power to the device, or
2. When you reset the part by toggling the INIT pin.

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